

# DATA SHEET

**TDA7052**

**1 W BTL mono audio amplifier**

Product specification  
File under Integrated Circuits, IC01

July 1994

**1 W BTL mono audio amplifier****TDA7052****GENERAL DESCRIPTION**

The TDA7052 is a mono output amplifier in a 8-lead dual-in-line (DIL) plastic package. The device is designed for battery-fed portable audio applications.

**Features:**

- No external components
- No switch-on or switch-off clicks
- Good overall stability
- Low power consumption
- No external heatsink required
- Short-circuit proof

**QUICK REFERENCE DATA**

| SYMBOL    | PARAMETER                 | CONDITIONS            | MIN. | TYP. | MAX. | UNIT |
|-----------|---------------------------|-----------------------|------|------|------|------|
| $V_P$     | Supply voltage range      |                       | 3    | 6    | 18   | V    |
| $I_{tot}$ | Total quiescent current   | $R_L = \infty$        | —    | 4    | 8    | mA   |
| $G_v$     | Voltage gain              |                       | 38   | 39   | 40   | dB   |
| $P_o$     | Output power              | THD = 10%; 8 $\Omega$ | —    | 1,2  | —    | W    |
| THD       | Total harmonic distortion | $P_o = 0,1$ W         | —    | 0,2  | 1,0  | %    |

**PACKAGE OUTLINE**

8-lead DIL; plastic (SOT97); SOT97-1; 1996 August 21.

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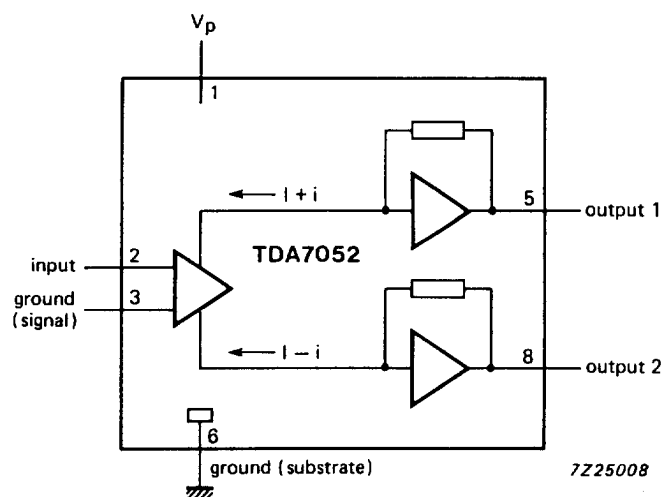


Fig.1 Block diagram.

## PINNING

|   |       |                 |   |      |                    |
|---|-------|-----------------|---|------|--------------------|
| 1 | $V_P$ | supply voltage  | 5 | OUT1 | output1            |
| 2 | IN    | input           | 6 | GND2 | ground (substrate) |
| 3 | GND1  | ground (signal) | 7 | n.c. | not connected      |
| 4 | n.c.  | not connected   | 8 | OUT2 | output2            |

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FUNCTIONAL DESCRIPTION

The TDA7052 is a mono output amplifier designed for battery-fed portable audio applications, such as tape recorders and radios.

The gain is fixed internally at 40 dB. A large number of tape recorders and radios are still designed for mono sound, plus a space-saving trend by reduction of the number of battery cells. This means a decrease in supply voltage which results in an reduction of output power. To compensate for this reduction, the TDA7052 uses the Bridge-Tied-Load principle (BTL) which can deliver an output power of 1,2 W (THD = 10%) into an 8 Ω load with a power supply of 6 V. The load can be short-circuited at each signal excursion.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL           | PARAMETER                          | MIN.       | MAX. | UNIT |
|------------------|------------------------------------|------------|------|------|
| V <sub>P</sub>   | Supply voltage                     | –          | 18   | V    |
| I <sub>OSM</sub> | Non-repetitive peak output current | –          | 1,5  | A    |
| P <sub>tot</sub> | Total power dissipation            | see Fig. 2 |      |      |
| T <sub>c</sub>   | Crystal temperature                | –          | 150  | °C   |
| T <sub>stg</sub> | Storage temperature range          | –55        | +150 | °C   |

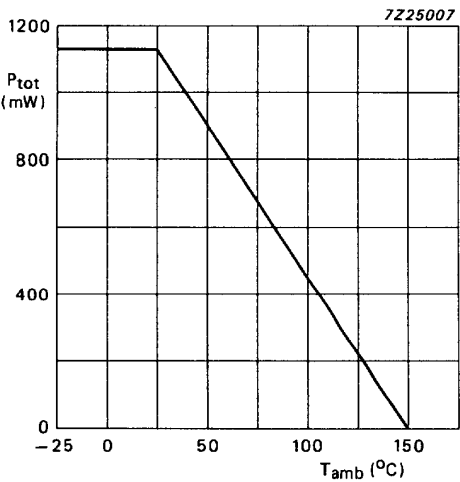


Fig.2 Power derating curve.

POWER DISSIPATION

Assume V<sub>P</sub> = 6 V; R<sub>L</sub> = 8 Ω; T<sub>amb</sub> = 50 °C maximum.

The maximum sinewave dissipation is 0,9 W.

$$R_{th\,j-a} = \frac{150 - 50}{0,9} \approx 110\text{ K/W.}$$

Where R<sub>th j-a</sub> of the package is 110 K/W, so no external heatsink is required.

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**CHARACTERISTICS**

$V_P = 6\text{ V}$ ;  $R_L = 8\ \Omega$ ;  $f = 1\text{ kHz}$ ;  $T_{\text{amb}} = 25\text{ }^\circ\text{C}$ ; unless otherwise specified.

| SYMBOL               | PARAMETER                           | CONDITIONS               | MIN. | TYP.               | MAX. | UNIT             |
|----------------------|-------------------------------------|--------------------------|------|--------------------|------|------------------|
| <b>Supply</b>        |                                     |                          |      |                    |      |                  |
| $V_P$                | Supply voltage range                |                          | 3    | 6                  | 18   | V                |
| $I_{\text{tot}}$     | Total quiescent current             | $R_L = \infty$           | –    | 4                  | 8    | mA               |
| $G_v$                | Voltage gain                        |                          | 38   | 39                 | 40   | dB               |
| $P_O$                | Output power                        | THD = 10%                | –    | 1,2                | –    | W                |
|                      | Noise output voltage<br>(RMS value) |                          |      |                    |      |                  |
| $V_{\text{no(rms)}}$ |                                     | note 1                   | –    | 150                | 300  | $\mu\text{V}$    |
| $V_{\text{no(rms)}}$ |                                     | note 2                   | –    | 60                 | –    | $\mu\text{V}$    |
| $f_r$                | Frequency response                  |                          | –    | 20 Hz to<br>20 kHz | –    | Hz               |
| SVRR                 | Supply voltage ripple rejection     | note 3                   | 40   | 50                 | –    | dB               |
|                      | DC output offset voltage            |                          |      |                    |      |                  |
| $\Delta V_{5-8}$     | pin 5 to 8                          | $R_S = 5\text{ k}\Omega$ | –    | –                  | 100  | mV               |
| THD                  | Total harmonic distortion           | $P_O = 0,1\text{ W}$     | –    | 0,2                | 1,0  | %                |
| $ Z_i $              | Input impedance                     |                          | –    | 100                | –    | $\text{k}\Omega$ |
| $I_{\text{bias}}$    | Input bias current                  |                          | –    | 100                | 300  | nA               |

**Notes to the characteristics**

1. The unweighted RMS noise output voltage is measured at a bandwidth of 60 Hz to 15 kHz with a source impedance ( $R_S$ ) of 5 k $\Omega$ .
2. The RMS noise output voltage is measured at a bandwidth of 5 kHz with a source impedance of 0  $\Omega$  and a frequency of 500 kHz. With a practical load ( $R = 8\ \Omega$ ;  $L = 200\ \mu\text{H}$ ) the noise output current is only 100 nA.
3. Ripple rejection is measured at the output with a source impedance of 0  $\Omega$  and a frequency between 100 Hz and 10 kHz. The ripple voltage = 200 mV (RMS value) is applied to the positive supply rail.

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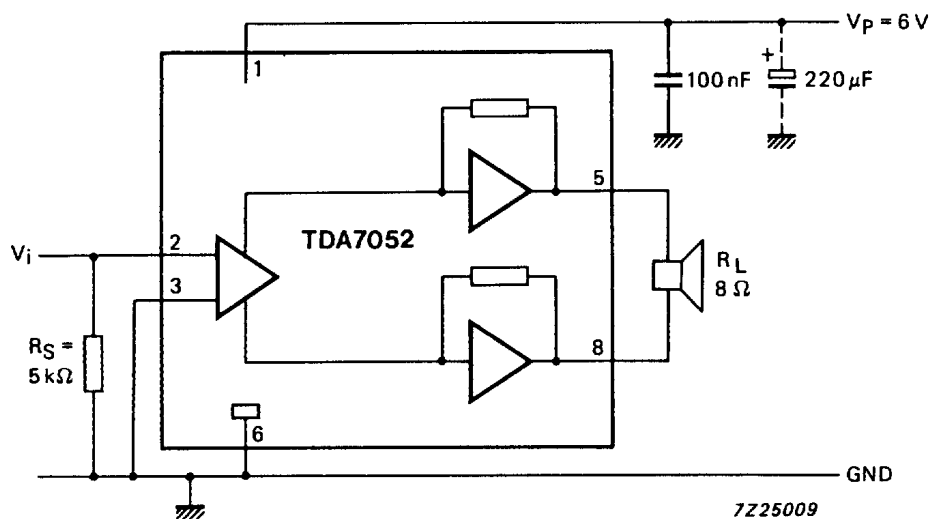


Fig.3 Application diagram.

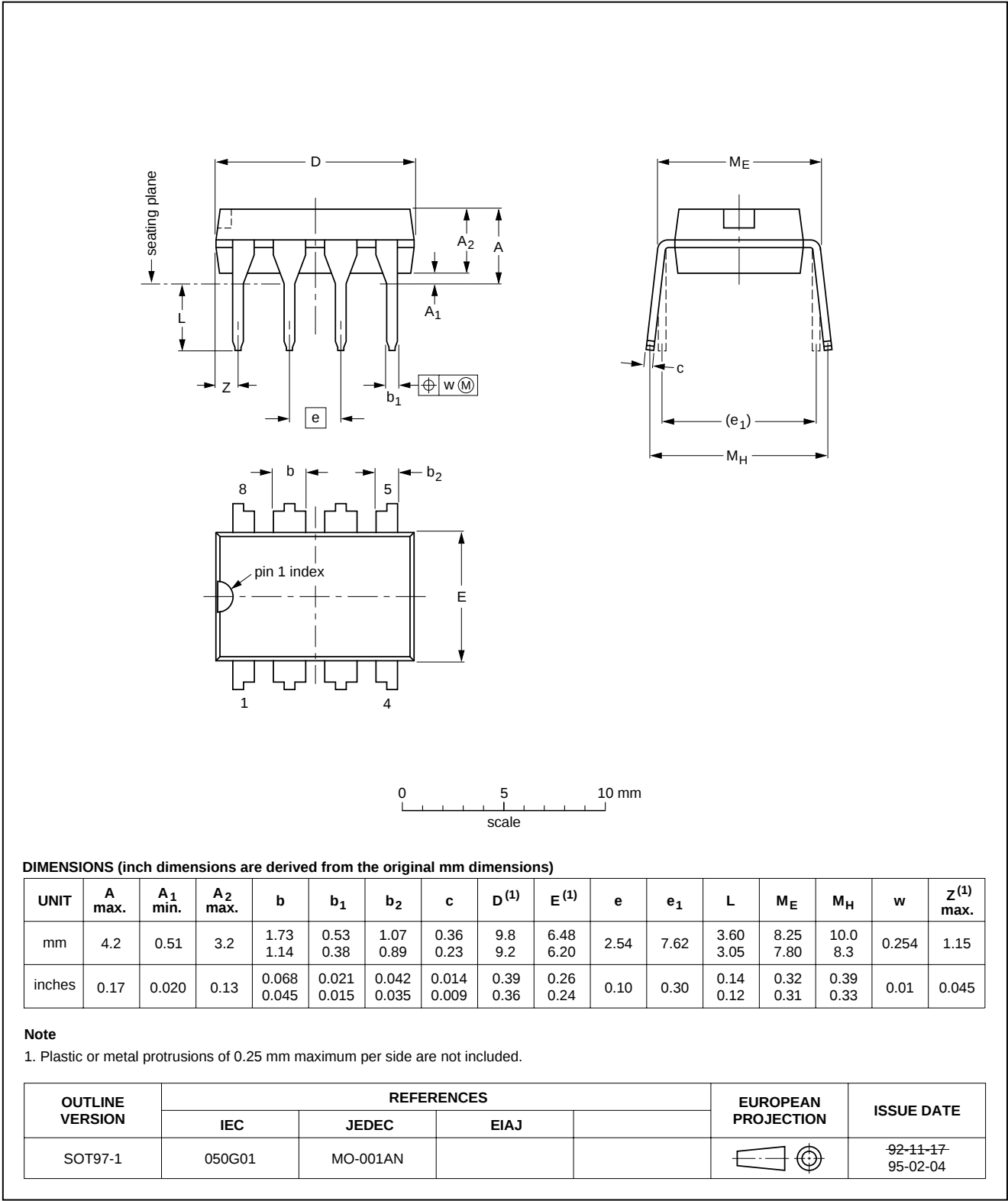
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PACKAGE OUTLINE

DIP8: plastic dual in-line package; 8 leads (300 mil)

SOT97-1



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**SOLDERING****Introduction**

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

**Soldering by dipping or by wave**

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg\ max}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

**Repairing soldered joints**

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

**DEFINITIONS**

| <b>Data sheet status</b>                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |
| <b>Limiting values</b>                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                                                       |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| <b>Application information</b>                                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |

**LIFE SUPPORT APPLICATIONS**

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